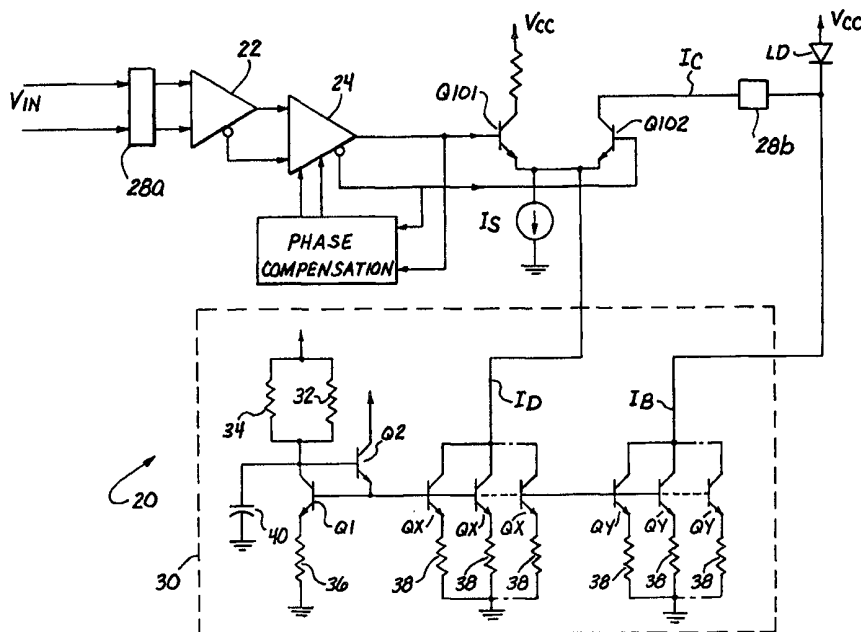




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(54) Title: TEMPERATURE COMPENSATION OF LASER DIODES



(57) Abstract

An analog circuit for thermal compensation of laser diodes in optical transmitters. A thermistor (32) senses laser diode (LD) temperature and controls a current source (30) which delivers both diode drive current and diode bias current. The novel circuit compensates for both reduction in laser diode output power and rise in threshold current of the laser diode with increasing temperature over a considerable range of operating temperatures.

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TEMPERATURE COMPENSATION OF LASER DIODES

Background of the Invention

5 Field of the Invention

This invention relates to laser diode transmitters of the type used in fiber-optic communication systems and more particularly is directed to compensating circuits for correcting the light output of the laser diode against
10 variations caused by changes in laser diode temperature.

State of the Prior Art

Semiconductor laser diodes are widely used as optical sources in fiber-optic communication links. The laser
15 diode is driven by an alternating current (a.c.) which represents the information to be transmitted over the optical fiber. The optical output of the laser diode, now also carrying the desired a.c. signal, is coupled to a corresponding optical fiber which conveys the optical
20 signal to a receiver coupled to the opposite end of the fiber, where the transmitted a.c. signal is recovered in electrical form for further processing. A given transmitter package may include one or several such laser

diodes, each with a corresponding diode driver circuit and coupled to a corresponding optical fiber.

Laser diodes have a characteristic threshold current which must be exceeded before any light output is emitted by the diode. In typical transmitter packages the laser diode is supplied with a bias current which places the diode at the threshold of optical emission. This is done in order to maintain linearity and signal strength of the a.c. signal being transmitted. The a.c. signal supplied by the diode driver circuit may be any signal varying in amplitude over time, although in digital communications it normally consists of a digital pulse train. The a.c. drive current input to the laser diode results in emission of a light output having a time-varying characteristic, typically the amplitude or intensity of the light output, representative of the a.c signal and carrying the desired information.

Semiconductor laser diodes are sensitive to changes in temperature of the environment in that the threshold current increases with rising temperature while the output level or intensity of the emitted light decreases with rising temperature. The temperature variations of concern

are changes in room temperature and/or heating in the instrument housing containing the laser diode transmitter. If no correction is made for this effect, the result is distortion of the a.c. signal carried by the light output
5 as well as diminished overall intensity of the light output. Both these consequences impair the quality of the communications link and may result in outright failure of the link if the light output of the laser diode falls below the minimum level detectable by the receiver at the
10 other end.

Much effort has been expended in devising means for correcting for this temperature susceptibility of laser diodes. The conventional approaches broadly fall into two
15 categories: optical feedback and active cooling. The optical feedback approach involves actually sensing the light output of the laser diode with a photo-detector, and connecting the output of the photo-detector for increasing drive current to the laser diode to compensate for
20 diminished output with rising temperature. Active cooling calls for refrigerating the laser diode by such means as Peltier junction devices in order to hold constant its temperature. The former approach fails to correct for

changes in threshold current of the laser diode, while the latter approach consumes excessive power.

Attempts have also been made to adjust the bias and
5 drive currents as a function of temperature to compensate for temperature induced changes in the corresponding laser diode operating characteristics. However, the changes in threshold current and drive current requirement vary as a function of temperature vary in a manner which can be
10 generally approximated by an exponential function. Known efforts along these lines have relied upon microprocessor systems equipped with tables of stored values representing the diode currents at closely spaced temperature points through the operating temperature range of the laser
15 diode. This approach requires digital memory as well as a microprocessor and supporting circuits, leading to undesirable complexity and excessive power requirements.

A continuing need exists for a more efficient approach to the temperature compensation of laser diodes.

20

Summary of the Invention

This invention responds to the aforementioned need by providing an analog circuit for thermal compensation of

laser diodes in optical transmitters in which laser diode temperature is sensed by a temperature dependent element such as a thermistor and the sensor output is used to control the level of the diode drive current as well as
5 the diode bias current in order to correct for changes in laser diode operating temperature.

The novel circuit is entirely analog in design, avoiding the greater complexity and power consumption of
10 digital processing, yet compensates for both the reduction in output power as well as the rise in threshold current of the laser diode with increasing temperature over a substantial range of operating temperatures.

15 More specifically, the temperature compensated laser diode transmitter circuit improved according to this invention has a laser diode; a driver circuit for supplying an a.c. drive current to the laser diode; a thermistor arranged in thermal sensing proximity to the
20 laser diode; a current source having a first and a second current output controlled by the thermistor; the first current output being connected to the driver for temperature compensating the drive current; the second

current output being connected for supplying a temperature compensated variable bias current to the laser diode.

That is, the first current output is operative for increasing the amplitude of the a.c. drive current with increasing temperature sensed by the thermistor and the
5 second current output is operative for supplying increased bias current with increasing temperature sensed by the thermistor.

10 The current source preferably includes a current mirror circuit supplying both the first and second current outputs. The thermistor may be connected as part of a resistance network in the current mirror circuit, including a parallel fixed resistance, selected to
15 approximate a temperature compensating current output curve of the current mirror circuit.

The invention may also be summarized as a temperature compensation circuit for a laser diode transmitter of the
20 type having a laser diode and a drive circuit for supplying an a.c. drive current to the laser diode thereby to derive a light output. In a presently preferred form the temperature compensation circuit has a single analog

current mirror circuit having first and second current
outputs connected respectively for controlling the
amplitude of the a.c. drive current and for supplying a
variable bias current to the laser diode, and a thermistor
5 arranged in thermal sensing relationship to the laser
diode and connected for controlling both of the current
outputs so as to compensate each of the a.c. drive current
amplitude and the laser diode bias current for variations
in temperature of the laser diode.

10

These and other improvements, features and advantages
of the present invention will be better understood by
reference to the following detailed description of the
preferred embodiments and the accompanying drawings.

15

Brief Description of the Drawings

Figure 1 is a perspective view of a typical laser
diode and thermistor arrangement in a fiber optical
20 transmitter;

Figure 2 is a schematic diagram of the analog
temperature compensation circuit; and

Figure 3 shows two curves plotting the increasing amplitude of the a.c. modulated drive current and the rising bias current as a function of laser diode operating
5 temperature.

Detailed Description of the Preferred Embodiments

With reference to the accompanying drawings in which
10 like elements are designated by like numerals, Figure 1 shows a laser diode array chip 12 which is mounted on a supporting substrate 16 and includes a number of individual laser diodes 14. An equal number of optical fibers 18 are supported on substrate 17 each with an end
15 face in optical alignment with a corresponding one of laser diodes 14. Connection pads 19 are provided on the laser array chip for supplying electrical power to each diode 14 by means of supply wires 21, there being a common ground connection, not shown in the Figure. The optical
20 fibers extend upwardly in Figure 1 to make-up a multi-fiber cable 15, at the opposite end of which is a receiver (not shown) with photo-detectors for converting the

optical signals from the fibers 18 to corresponding electrical signals for further processing.

The laser diodes 14 are each driven by a corresponding driver circuit which delivers an alternating current modulated with the information to be conveyed by the emitted optical signals over the fibers 18. Figure 2 depicts in block circuit diagram the driver circuit and associated temperature compensation circuit corresponding to one of the laser diodes 14. The circuit of Figure 2 represents a single laser diode drive channel, and this circuit is repeated for each laser diode 14 of the diode array 12 to provide multiple parallel driver channels. For the sake of clarity only one such circuit is shown in the Figure. In typical high performance systems the driver circuits handle high frequency signals and in a presently preferred embodiment all the laser diode driver channels are implemented in silicon bipolar technology on a single integrated circuit, with, for example, 27 GigaHertz unity-gain frequency for IEEE standard PECO interface transmitters.

Turning to Figure 2, the laser diode driver circuit generally designated by numeral 20, may be of conventional

design and includes a first amplifier stage 22 functioning as a comparator which receives an alternating signal input V_{in} and is followed by a second amplifier and phase compensation stage 24. The output of stage 24 drives
5 transistor Q101 of differential transistor pair Q101, Q102. Transistor Q101 is connected between voltage supply V_{cc} and a constant current supply circuit I_s , while transistor Q102 is connected between constant current supply I_s and laser diode LD. The differential transistor
10 pair delivers an a.c. drive current to the laser diode LD. The driver circuit includes suitable electrostatic discharge protection circuits 28a, 28b, at the input and output respectively.

15 The temperature compensation control circuit generally designated by numeral 30 includes transistors Q1 and Q2, and two groups of parallel connected load transistors Qx and Qy, all connected in a current mirror circuit configuration. The current mirror circuit is
20 "programmed", i.e. its output current is determined by a programming current determined by a resistance network including thermistor 32 connected in parallel with fixed resistance 34, and emitter resistor 36. Capacitance 40

improves stability of the circuit. The thermistor 32 is physically positioned and mounted in thermal sensing proximity to the laser diode array 12 on common substrate 16, as shown in Figure 1.

5

The current mirror circuit has two current outputs, a drive current control output I_D supplied jointly by transistors Q_x , and a variable bias current output I_B supplied jointly by transistors Q_y . The driver control current output I_D is connected to the emitters of the differential transistor pair $Q101$, $Q102$ in parallel with the constant current source I_s . The variable bias current output I_B is connected to the laser diode LD and supplies a continuous forward bias to the diode.

15

The temperature control circuit 30 is designed so that the variable bias current I_b tracks changes in the threshold current level of diode LD with changes in the diode operating temperature. That is, the variable bias current varies with variations in the temperature sensed by thermistor 32. These changes in temperature may reflect changes in ambient temperature caused by environmental factors and/or by waste heat generated in an

20

enclosure housing the optical transmitter package.
Thermistor 32 is a negative temperature coefficient (NTC) device, so that as the threshold current level of diode LD rises with temperature, the bias current delivered by the
5 compensation circuit 30 also rises to keep the laser diode close to its lasing light emission threshold.

The drive control current output I_D likewise tracks variations in ambient temperature sensed by thermistor 32,
10 and this control current is added to the constant current supplied by constant current source I_s . These two currents summed together control the amplitude of the a.c. drive current delivered to laser diode. The sum of constant current I_s and drive control current I_D controls
15 and a.c. drive current output I_C of the laser diode driver circuit 20. This I_C drive current is actually a composite current in that it includes a d.c. component attributable to the influence of constant current source I_s on the output of the differential transistor pair. This d.c.
20 component contributes to the forward bias of the laser diode and is summed to the temperature compensating bias current I_B to provide a base or minimum bias current.

The lasing efficiency of the diode LD decreases with rising temperature. Accordingly, the compensation circuit 20 is designed so that the drive control current varies in relation to temperature, increasing with rising

5 temperature to increase the a.c. drive current delivered to the laser diode, and conversely, decreasing diode drive current with falling temperature, so as to maintain approximately constant the light power output of the diode over a range of operating temperatures of the optical

10 transmitter and compensate for the characteristic response of the laser diode to ambient temperature changes.

The combined effect of the variable bias current and the drive control current is to maintain the modulated

15 light output of the laser diode within an acceptable range of output power levels and modulation over an intended operating temperature range of the transmitter package. It is preferred to implement the temperature compensation circuit 30 on-chip together with the driver circuit 20 for

20 best temperature stability as well as for cost and size considerations. Presently preferred values and part number for select components of the compensation circuit 30 are given by the following Table 1.

Table 1

5	Thermistor 32	HM35NF-103K
	Fixed resistance 34	3 kiloOhms
	Emitter resistance 36	115 Ohms
	Emitter resistance 38	80 Ohms
	Capacitance 40	2 picoFarads

10 In a presently preferred mirror circuit, the first load transistor group includes 3 transistors Qx while the second load transistor group includes 6 transistors Qy, each with a corresponding emitter resistance 38. In an exemplary circuit, which has an intended operating

15 temperature range of 0°C to 90°C, Table 2 below lists values for the drive control current I_D , the variable bias current I_B , constant current I_S and thermistor resistance R_T at two widely spaced temperature points.

20

Table 2

T	I_B	I_D	I_S	R_t
25°C	2.56 mA	5.18 mA	2.57 mA	10 Kohms
80°C	7.18 mA	14.52 mA	2.57 mA	1.2 Kohms

The current contributed by each transistor Qx and IQy

25 is the total current output of the corresponding load group divided by the number of transistors in that group, i.e. three transistors Qx and six transistors Qy.

The laser diode threshold current I_b as a function of temperature for a typical laser diode is given by the following exponential function:

5

$$I = 25 \cdot e^{\frac{T-25}{50.06}}$$

where the denominator of the exponent is the current gain of transistors Q_y in the current mirror circuit, while the temperature dependent laser diode drive current function for the same device, i.e. the drive current I_c required to maintain a constant light output is approximated, as a best fit to experimentally derived data, by the following expression, which is also an exponential function:

10
15

$$I = 10 \cdot e^{\frac{T-25}{60.02}}$$

where T is the temperature of the laser diode denominators in the first and second exponents of the difference equation are the current gain factors of the transistors Q_x , Q_y respectively in the current mirror unit.

20

The drive and bias currents I_C and I_B actually delivered by circuit 30 over a given temperature range can be made to follow these exponential functions to within 5 or 10% as a result of a combination of several temperature dependent circuit parameters, primarily the variable resistance of thermistor 32, but also the temperature variation of the current gain of transistors Q_x , Q_y in the current mirror circuit, the temperature induced variation in the current gain of the differential pair, and non-linear operation of the differential transistor pair Q_{101} , Q_{102} .

Notwithstanding its analog nature, the current outputs I_C , I_B of the temperature compensated laser diode drive circuit 20 of this invention change with temperature in a manner which sufficiently approximates the above mentioned exponential functions. Measured circuit performance shows that the temperature compensated bias and drive currents delivered by the circuit of this invention can generally approximate the actual exponential function to within about $\pm 5\%$, a result which has been found quite satisfactory in operation of the optoelectronic transmitter.

Figure 3 shows two curves labeled "High" and "Low". The High curve plots the maximum or peak a.c. drive current output or I_{Cmax} and the Low curve plots the bias current output I_B , both over an operating temperature range of 0°C to 90°C of the laser diode LD. These two curves depict the actual currents delivered to the laser diode but are based on a limited number of data points and so do not show current fluctuations above and below the curves which actually occur. However, these fluctuations remain within about the aforementioned $\pm 5\%$ figure of the values indicated by the two curves.

The vertical spread between the upper and lower curves represents the amplitude swing of the a.c. drive current I_C , plus its d.c. component mentioned earlier. That is, the lower curve represents the temperature compensating bias current I_B which keeps the diode LD at or near its lasing threshold. To this is summed the composite a.c./d.c. modulated drive current I_C responsible for the modulated light output of the laser diode. As seen in Figure 3 drive current I_C rises more steeply with increasing temperature than the bias current output I_B

over the same temperature range, resulting in increasing amplitude of the a.c. component swing with increasing temperature, to compensate for diminishing efficiency of the laser diode.

5 From the foregoing description it will be appreciated that the laser diode temperature compensation circuit is entirely analog in design so that it may be conveniently implemented on board a high frequency integrated circuit laser diode driver with a minimum of external parts.

10

 While a particular embodiment of the invention has been described and illustrated for purposes of clarity and example it must be understood that many changes, modifications and substitutions to the described
15 embodiment, including various choices and adjustments to the operating circuit parameters needed to obtain a desired current output/temperature response of the compensation circuit, will be apparent to those having ordinary skill in the art without thereby departing from
20 the scope of this invention as defined in the following claims.

 What is claimed is:

CLAIMS

1. A temperature compensated laser diode transmitter circuit, comprising:
 - a laser diode;
 - 5 a driver circuit for supplying an a.c. drive current to said laser diode;
 - a thermistor arranged in thermal sensing proximity to said laser diode; and
 - a current source having a first and a second current
 - 10 output controlled by said thermistor;
 - said first current output connected to said driver for temperature compensating said drive current; said second current output connected for supplying a temperature compensated bias current
 - 15 to said laser diode.

2. The temperature compensated circuit of Claim 1 wherein said first current is operative for increasing the amplitude of said a.c. drive current with increasing
- 20 temperature sensed by said thermistor.

3. The temperature compensated circuit of Claim 1 wherein said temperature compensated bias current increases with

increasing temperature sensed by said thermistor.

4. The temperature compensated circuit of Claim 1 wherein
said current source comprises a current mirror circuit
5 supplying both said first and second current output.

5. The temperature compensated circuit of Claim 1 wherein
said thermistor is connected in parallel with a fixed
resistance.

10

6. The temperature compensated circuit of Claim 1 wherein
said current source is an analog circuit.

7. The temperature compensated circuit of Claim 6 wherein
15 both said a.c. drive current and said bias current each
varies along an exponential temperature compensated
current output curve responsive to temperature induced
variations in resistance of said thermistor.

20 8. The temperature compensated circuit of Claim 7 wherein
said a.c. drive current has an amplitude which increases
with increasing temperature sensed by said thermistor.

9. A temperature compensated laser diode transmitter circuit, comprising:

a laser diode, a driver circuit for supplying an a.c. drive current to said laser diode thereby to derive a light output, an analog current supply circuit having a first and a second current outputs, a thermistor positioned in thermally responsive proximity to said laser diode and connected in said analog current supply circuit for controlling both said first and said second current outputs, said first of said current outputs being connected to said driver circuit for controlling the amplitude of said a.c. drive current, said second of said current outputs being connected for supplying a bias current to said laser diode, such that both drive current amplitude and diode bias current are compensated for temperature variations of said laser diode thereby to reduce variations in said light output.

10. A temperature compensation circuit for a laser diode transmitter of the type having a laser diode and a drive circuit for supplying an a.c. drive current to said laser diode thereby to derive a light output, comprising:
a single analog current mirror circuit having first and

second current outputs connected respectively for
controlling the amplitude of said a.c. drive current and
for supplying a bias current to said laser diode, and a
thermistor arranged in thermal sensing relationship to the
5 laser diode and connected for controlling both of said
current outputs so as to increase the amplitude of the
a.c. drive current amplitude and also increase the laser
diode bias current in generally exponential relationship
with the operating temperature of the laser diode thereby
10 to reduce variations in laser diode light output over a
range of operating temperatures.

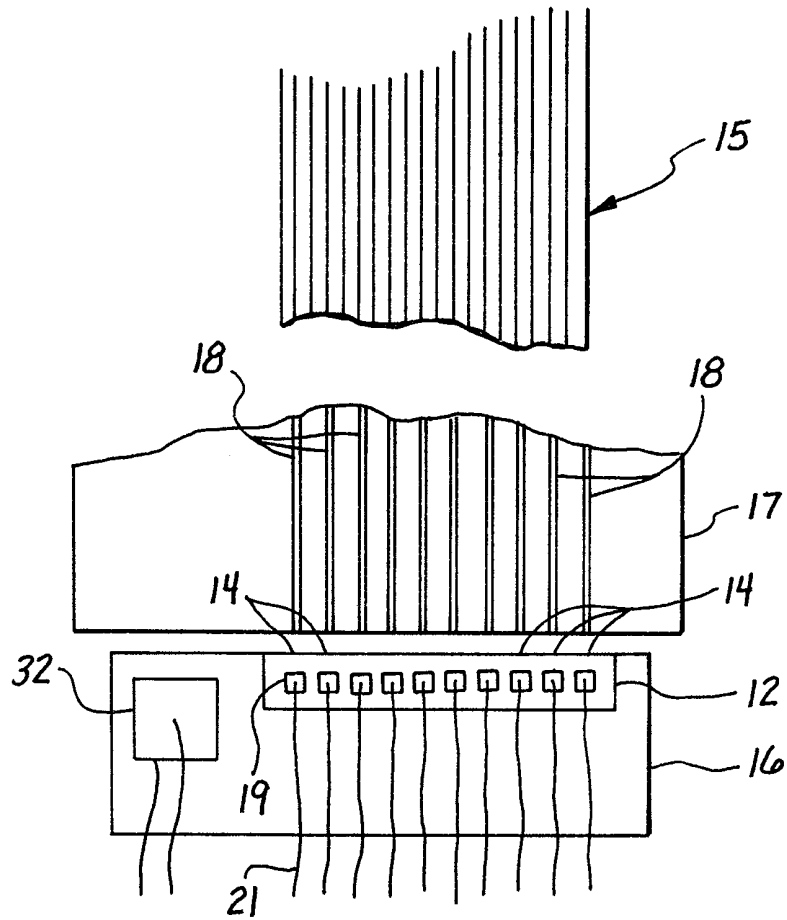


Fig. 1

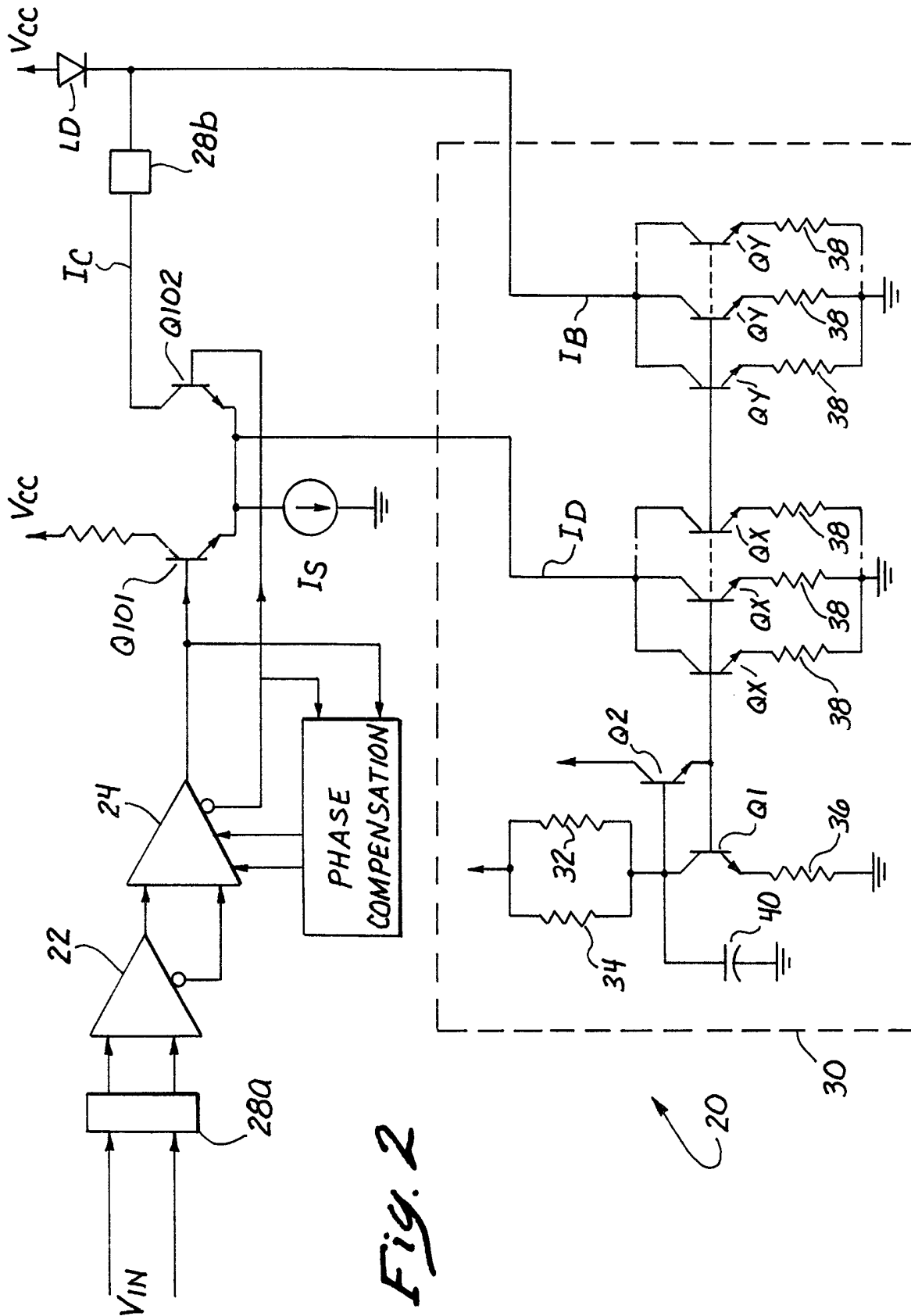
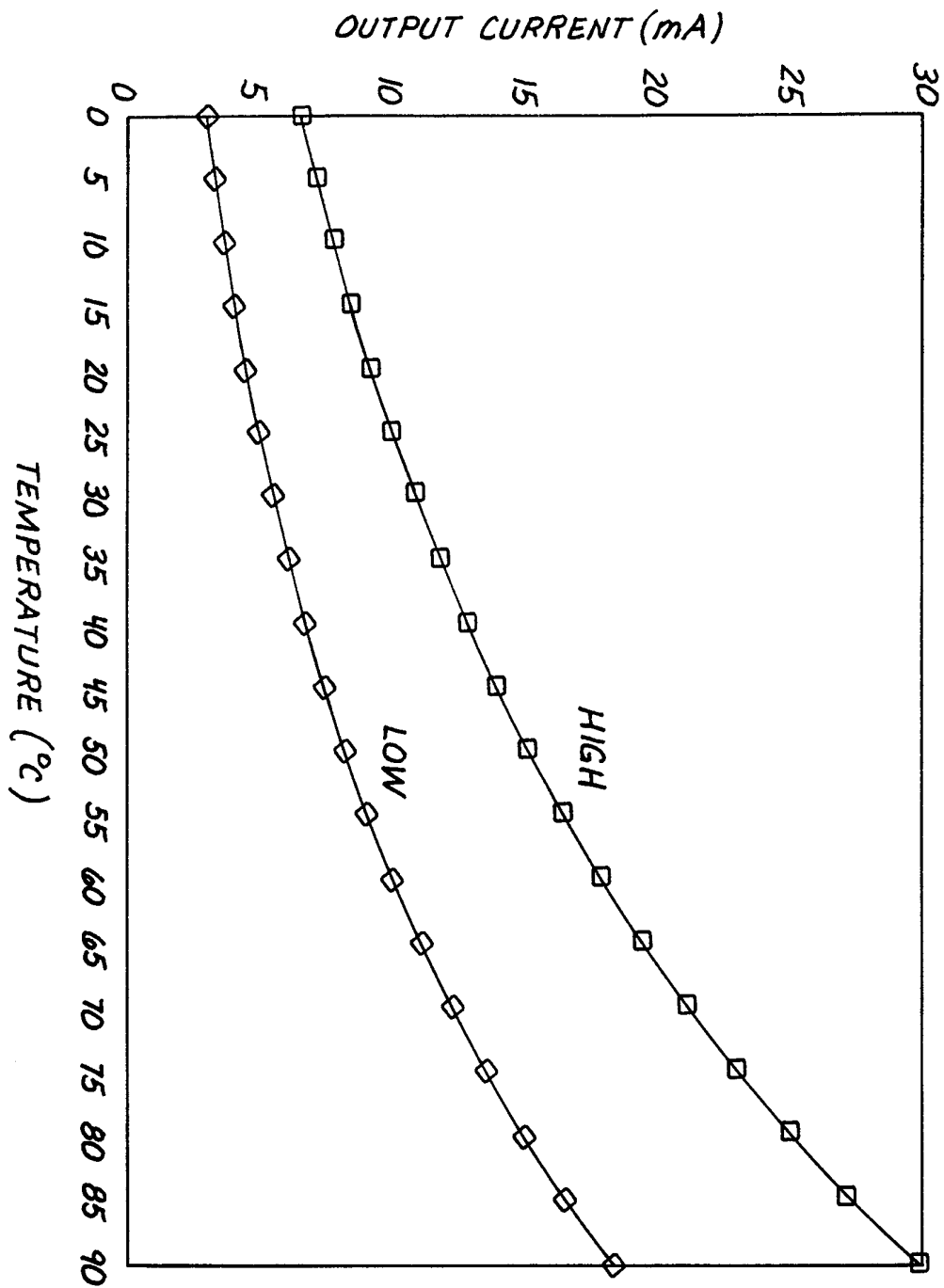


Fig. 2



OUTPUT CURRENT TO LASER DIODE **Fig. 3**

INTERNATIONAL SEARCH REPORT

International application No.
PCT/US99/08116

A. CLASSIFICATION OF SUBJECT MATTER
 IPC(6) :H01S 3/00
 US CL :372/38
 According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED
 Minimum documentation searched (classification system followed by classification symbols)
 U.S. : 372/38, 31, 34

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)
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C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	US 4,243,952 A (PATTERSON) 06 January 1981 (06/01/81), see the entire document.	1-10
A, P	US 5,761,230 A(OONO ET AL) 02 June 1998 (02/06/98), see the entire document.	1-10
A,P	US 5,760,939 A (NAGARAJAN ET AL) 02 June 1998 (02/06/98), see the entire document.	1-10

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